

Members in Attendance

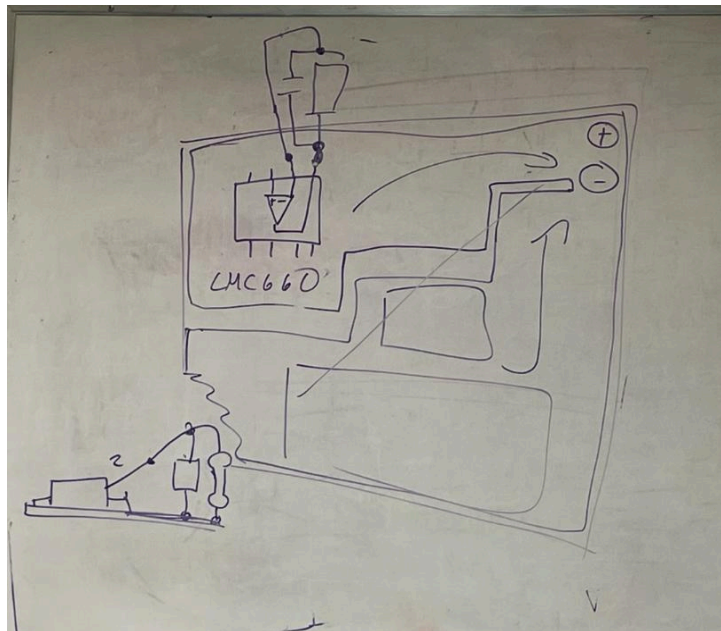
- Josh Mendez (Sponsor/Advisor)
- Nathan Truong
- Felix Moss
- Annika Boyd
- Eisa Alsharifi

Agenda

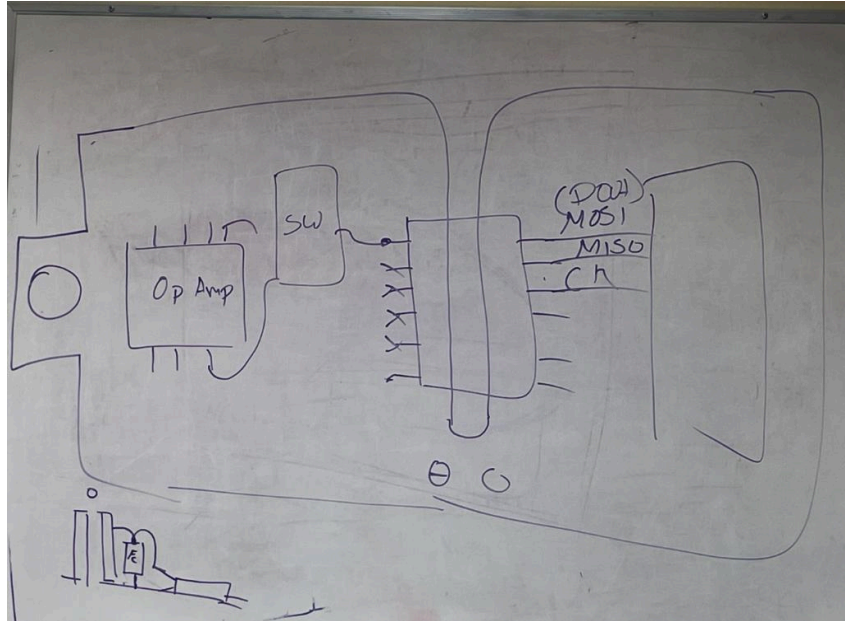
- Breadboard testing
- PCB prep

Notes

- Josh looked at our pcb on kicad
 - Wires going from faraday cup too exposed to leakage currents
 - Make ground pour that keeps signals that use it away from sensitive elements of the circuit
 - Make a split in the plane between the sensitive parts and the non-sensitive parts
 - For the op-amp, bend (-) pin up and solder the components that need to connect to it off the board (these components are the cap and resistor in the op amps feedback loop)



- Bottom left is air-connected components, middle is the split ground plane, arrows are the path that ground connected signals will take. There will be minimal signal noise and leakage current using these techniques
- Digital on one side analog on the other



This technique

- would be better, with components that are digital on one side and analog on the other.
- If using surface mount, use 0805 or 1206, or just use thru-hole
- Would prefer to use thru-hole opamp
- Tube
 - Start out with quarter inch
 - Make footprint a few mm larger
 - $D = 8\text{mm}$
 - Internal hole is 4mm, open thru the board
 - 4in tall

Deliverables

- Update the PCB (V1.1) and prepare for print
- Prepare CAD for tube